UNIVERSITI TEKNOLOGI MARA

ENHANCEMENT OF BANDWIDTH IN MICROSTRIP ANTENNA THROUGH DEFECTED GROUND STRUCTURE AND SYMMETRICAL CUT ON PATCH

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i

ABSTRACT

The purpose of this paper is to report the process and the achievement of the bandwidth enhancement through Defected Ground Structure (DGS) and Symmetrical Cut on the patch. This antenna is designed for S-band application resonates at 2.45 GHz. The design procedure is presented and the characteristic and the performance of the antenna are analyzed. This patch antenna was fabricated on RO3003 substrate. The simulations were done using Computer Simulation Technology Microwave Studio (CST-MWS) and the measurement was using Vector Network Analyzer (VNA) and Radio frequency (RF) Signal Generator. Based on the simulation, the antenna shows improvements in term of bandwidth and return loss of 53.33% and 163.33%, respectively. The overall size of patch area was also reduced up to 34.3%.

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TABLE OF CONTENTS

Page

CONFIRMATION BY PANEL OF EXAMINERS	ii
AUTHOR'S DECLARATION	iii
ABSTRACT	iv
AKNOWLEDGMENT	V
TABLE OF CONTENTS	vi
LIST OF TABLES	ix
LIST OF FIGURES	X
LIST OF SYMBOLS	xii
LIST OF ABBREVIATIONS/NOMENCLATURE	xiv

CHAPTER ONE: INTRODUCTION

1. 1	Research Background	1
	1.1.1 Microstrip Patch Antenna	1
	1.1.2 Defected Ground Structure	3
1.2	Problem Statement	4
1.3	Objective	4
1.4	Scope of Works	5
1.5	Thesis Organization	5

CHAPTER TWO: LITERATURE REVIEW

Antenna Review	7
Antenna Properties	8
2.2.1 Polarization	8
2.2.2 Bandwidth	9
2.2.3 Radiation Pattern	9
2.2.4 Beam-width	13
2.2.5 Return Loss	13
2.2.6 Gain	14
	2.2.2 Bandwidth2.2.3 Radiation Pattern2.2.4 Beam-width2.2.5 Return Loss

	2.2.7 Directivity	15
	2.2.8 Voltage Standing Wave Ratio (VSWR)	15
2.3	Microstrip Patch Antenna	15
	2.3.1 Overview	16
	2.3.2 Rectangular Patch Antenna	17
2.4	Defected Ground Structure	19
	2.4.1 Overview	19
	2.4.2 Past Works Review	20

CHAPTER THREE: METHODOLOGY

3.1	Flowchart	23
3.2	Antenna Design	25
	3.2.1 Conventional Microstrip Patch Antenna Design	25
	3.2.2 Proposed Antenna Design	29
3.3	Antenna Realization	34
	3.3.1 Generate Mask on Transparency Film	34
	3.3.2 Photo Exposure Process	34
	3.3.3 Etching in Developer Solution	34
	3.3.4 Etching in Ferric Chloride	35
	3.3.5 Soldering the Probe	35
	3.3.6 Physical View	35
3.4	Parametric Study	38
3.5	Measurement	38

CHAPTER FOUR: RESULTS AND DISCUSSIONS

4.1	Parametric Study	40
	4.1.1 Inset Feed Length, y_0	40
	4.1.2 Patch Width, W_{ν}	41
	4.1.3 Patch Length, L	42
	4.1.4 Substrate's Width, W_s and Substrate's Length, L_s	42
4.2	Simulation Results	44
4.3	Measurement Results	49